

1. Description

HMG40N65FT is obtained by advanced Trench Field Stop (T-FS) technology which is characteristic with low $V_{CE(sat)}$, optimized switching performance and low gate charge Q_g . The IGBT is suitable device for welding, UPS, and high switching frequency applications.

KEY CHARACTERISTICS

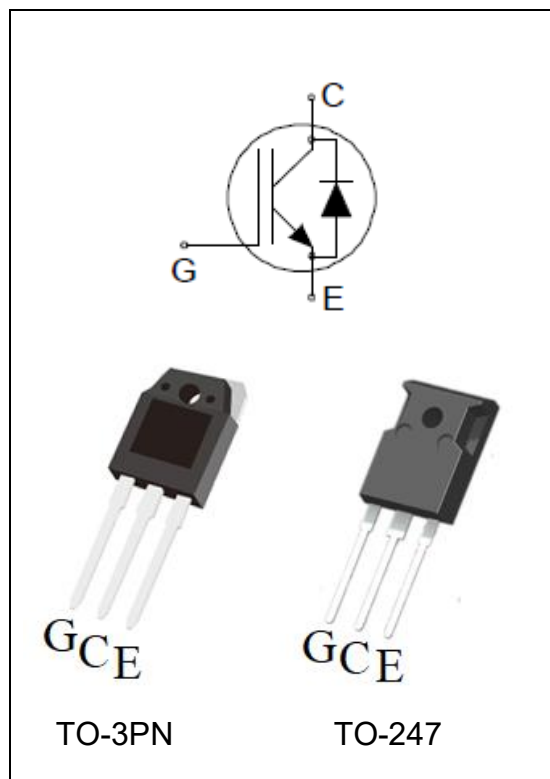
Parameter	Value	Unit
V_{CES}	650	V
I_C	40	A
$V_{CE(sat).typ}$	1.7	V

FEATURES

- Fast Switching
- Low $V_{CE(sat)}$
- Positive temperature coefficient
- Fast recovery anti-parallel diode
- RoHS product

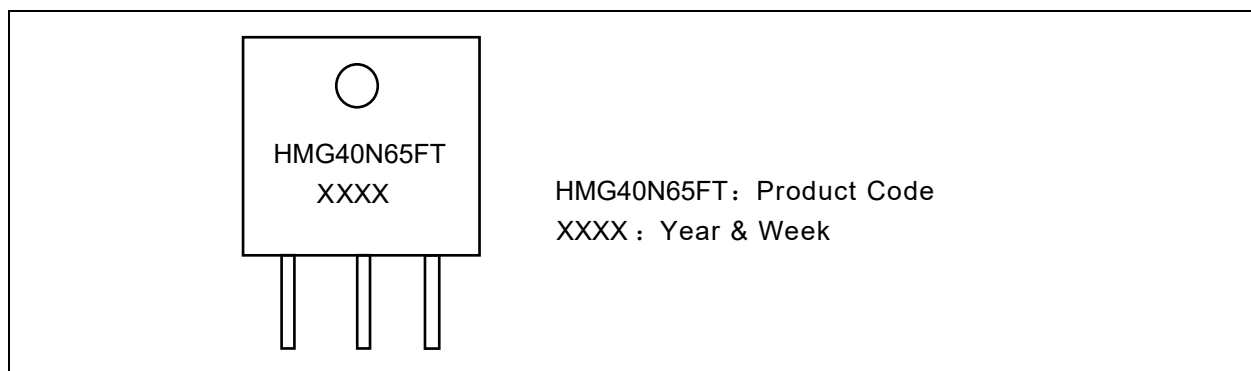
APPLICATIONS

- Welding converters
- UPS
- Boost Chopper
- Air condition



ORDERING INFORMATION

Device Marking	Ordering Codes	Package	Product Code	Packing
HMG40N65FT XXXX	HMG40N65FT	TO-247	G40T65FDK	Tube



2. ABSOLUTE RATINGS

Symbol	Parameter	Values	Units
V_{CES}	Collector-Emitter Voltage	650	V
I_C	Collector Current @ $T_C=25^{\circ}\text{C}$	80	A
	Collector Current @ $T_C=100^{\circ}\text{C}$	40	A
I_{CM}	Pulsed Collector Current, tp limited by T_{Jmax}	160	A
I_F	Diode Continuous Forward Current @ $T_C=25^{\circ}\text{C}$	80	A
	Diode Continuous Forward Current @ $T_C=100^{\circ}\text{C}$	40	A
I_{FM}	Diode Maximum Forward Current, limited by T_{Jmax}	160	A
V_{GES}	Gate-Emitter Voltage	± 20	V
t_{SC}	Short circuit withstand time $V_{GE}=15\text{V}$, $V_{CC}\leq 400\text{V}$, Allowed number of short circuits<1000, Times between short circuits: $\geq 1.0\text{s}$, $T_J\leq 175^{\circ}\text{C}$	3.0	μs
P_D	Power Dissipation @ $T_C=25^{\circ}\text{C}$	300	W
T_{Jmax}, T_{stg}	Operating Junction and Storage Temperature Range	175, -55 to 175	$^{\circ}\text{C}$
T_L	Maximum Temperature for Soldering	260	$^{\circ}\text{C}$

3. Thermal characteristics

Symbol	Parameter	Values	Units
$R_{\theta JC}$	Junction-to-Case (IGBT)	0.5	$^{\circ}\text{C/W}$
$R_{\theta JC}$	Junction-to-Case (Diode)	0.65	$^{\circ}\text{C/W}$
$R_{\theta JA}$	Junction-to-Ambient	40	$^{\circ}\text{C/W}$

4. Electrical Characteristics

at $T_C = 25^{\circ}\text{C}$, unless otherwise specified

Static Characteristics

Symbol	Parameter	Test Conditions	Values			Units
			Min.	Typ.	Max.	
V_{CES}	Collector-Emitter Breakdown Voltage	$V_{GE} = 0\text{V}$, $I_C = 250\mu\text{A}$	650	--	--	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE} = 15\text{V}$, $I_C = 40\text{A}$ $T_J=25^{\circ}\text{C}$	--	1.70	--	V
$V_{GE(TH)}$	Gate Threshold Voltage	$V_{CE} = V_{GE}$, $I_C = 1\text{mA}$	4.0	5.0	6.2	V

V_F	Diode Forward Voltage	$I_F=40A$ $T_J=25^{\circ}C$ $T_J=125^{\circ}C$ $T_J=175^{\circ}C$	-- -- --	2.20 1.80 1.60	2.90 -- --	V
I_{CES}	Collector-Emitter Leakage Current	$V_{CE} = 650V$, $V_{GE} = 0V$	--	--	50	μA
$I_{GES(F)}$	Gate-Emitter Forward Leakage Current	$V_{GE} = +30V$	--	--	100	nA
$I_{GES(R)}$	Gate-Emitter Reverse Leakage Current	$V_{GE} = -30V$	--	--	-100	nA
Pulse width $t_p \leq 300\mu s$, $\delta \leq 2\%$						

Dynamic Characteristics

Symbol	Parameter	Test Conditions	Values			Units
			Min.	Typ.	Max.	
C_{iss}	Input Capacitance	$V_{GE}=0V$ $V_{CE}=30V$ $f=1.0MHz$	--	2480	--	pF
C_{oss}	Output Capacitance		--	116	--	
C_{rss}	Reverse Transfer Capacitance		--	21	--	
Q_G	Gate charge	$V_{CC}=520V$ $I_{CE}=20A$ $V_{GE}=15V$	--	110	--	nC
Q_{GE}	Gate-emitter charge		--	52	--	
Q_{GC}	Gate-collector charge		--	23	--	
$I_{C(SC)}$	Short circuit collector current Max.1000 short circuits, Times between short circuits: $\geq 1.0s$	$V_{GE}=15.0V, V_{CC} \leq 400V$, $t_{sc} \leq 3\mu s$, $T_J \leq 175^{\circ}C$		320		A

IGBT Switching Characteristics, at $T_J=25^{\circ}C$

Symbol	Parameter	Test Conditions	Values			Units
			Min.	Typ.	Max.	
$t_{d(on)}$	Turn-on Delay Time	$I_C = 40A$ $V_{CE} = 400V$ $V_{GE} = 15V$ $R_G = 5\Omega$ $T_J=25^{\circ}C$ Inductive Load	--	32	--	ns
t_r	Rise Time		--	59	--	
$t_{d(off)}$	Turn-Off Delay Time		--	110	--	
t_f	Fall Time		--	26	--	
E_{on}	Turn-On Switching Loss		--	0.60	--	mJ
E_{off}	Turn-Off Switching Loss		--	0.60	--	
E_{ts}	Total Switching Loss		--	0.98	--	

IGBT Switching Characteristics, at $T_J=175^{\circ}\text{C}$

Symbol	Parameter	Test Conditions	Values			Units
			Min.	Typ.	Max.	
$t_{d(on)}$	Turn-on Delay Time	$I_C = 40\text{A}$ $V_{CE} = 400\text{V}$ $V_{GE} = 15\text{V}$ $R_G = 5\Omega$ $T_J = 175^{\circ}\text{C}$ Inductive Load	--	17	--	ns
t_r	Rise Time		--	32	--	
$t_{d(off)}$	Turn-Off Delay Time		--	142	--	
t_f	Fall Time		--	36	--	
E_{on}	Turn-On Switching Loss		--	0.8	--	mJ
E_{off}	Turn-Off Switching Loss		--	0.65	--	
E_{ts}	Total Switching Loss		--	1.45	--	

Diode Characteristics, at $T_J=25^{\circ}\text{C}$

Symbol	Parameter	Test Conditions	Values			Units
			Min.	Typ.	Max.	
T_{rr}	Reverse Recovery Time	$I_F = 20\text{A}$, $di/dt = 200\text{A}/\mu\text{s}$, $T_J = 25^{\circ}\text{C}$	--	162	--	ns
Q_{rr}	Reverse Recovery Charge		--	148	--	nC
I_{rrm}	Reverse Recovery Current		--	2.0	--	A
T_{rr}	Reverse Recovery Time	$I_F = 40\text{A}$, $di/dt = 200\text{A}/\mu\text{s}$, $T_J = 25^{\circ}\text{C}$	--	180	--	ns
Q_{rr}	Reverse Recovery Charge		--	190	--	nC
I_{rrm}	Reverse Recovery Current		--	2.5	--	A

Diode Characteristics, at $T_J=175^{\circ}\text{C}$

Symbol	Parameter	Test Conditions	Values			Units
			Min.	Typ.	Max.	
T_{rr}	Reverse Recovery Time	$I_F = 20\text{A}$, $di/dt = 200\text{A}/\mu\text{s}$, $T_J = 175^{\circ}\text{C}$	--	216	--	ns
Q_{rr}	Reverse Recovery Charge		--	156	--	nC
I_{rrm}	Reverse Recovery Current		--	4.2	--	A
T_{rr}	Reverse Recovery Time	$I_F = 40\text{A}$, $di/dt = 200\text{A}/\mu\text{s}$, $T_J = 175^{\circ}\text{C}$	--	251	--	ns
Q_{rr}	Reverse Recovery Charge		--	209	--	nC
I_{rrm}	Reverse Recovery Current		--	4.5	--	A

5. Characteristics Curves

Figure 1. Forward Bias Safe Operating Area for TO3PN/TO247

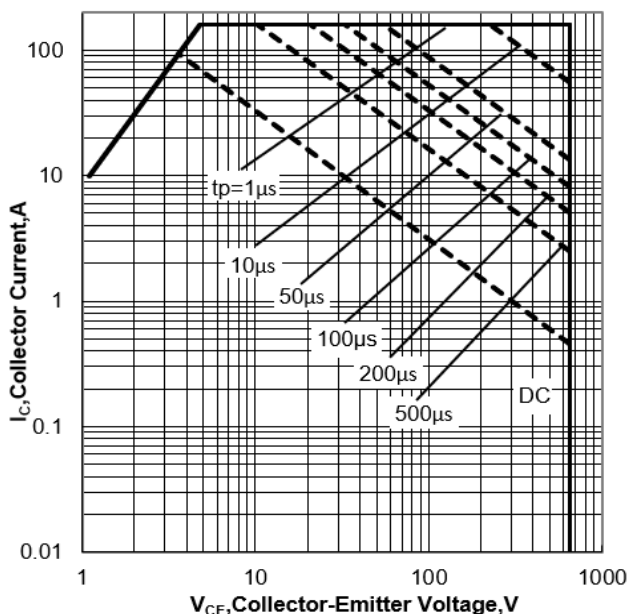


Figure 2. Power Dissipation vs Case Temperature for TO3PN/TO247

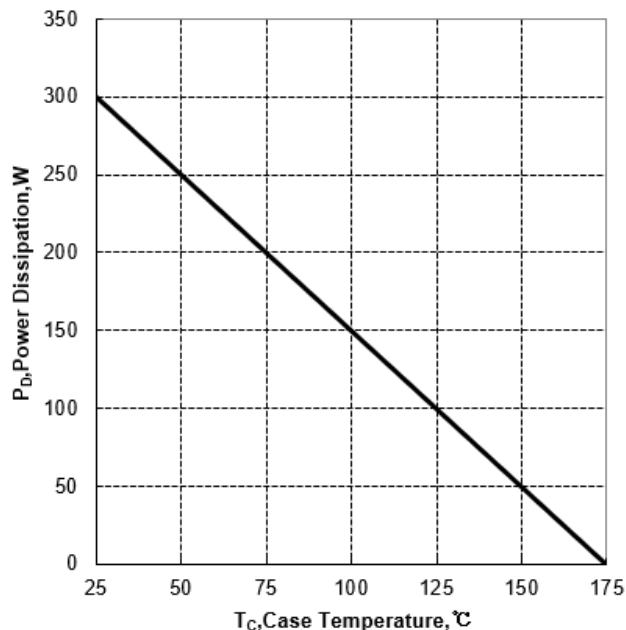


Figure 3. Collector Current vs Case Temperature

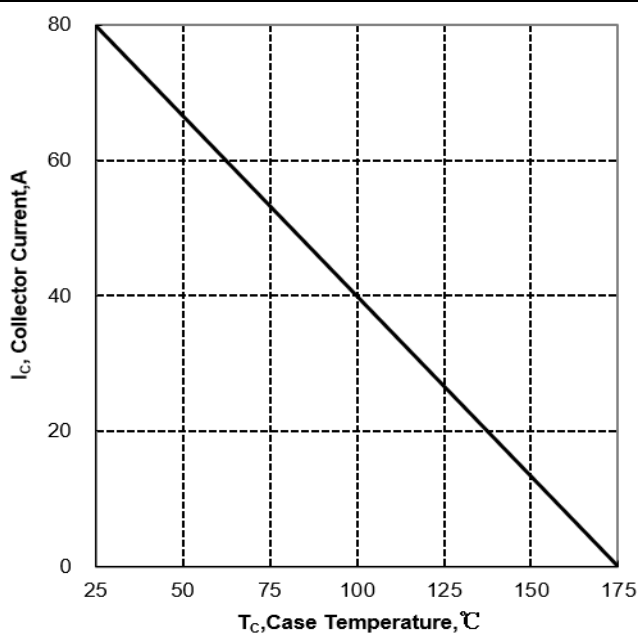


Figure 4. Typical Transfer Characteristics

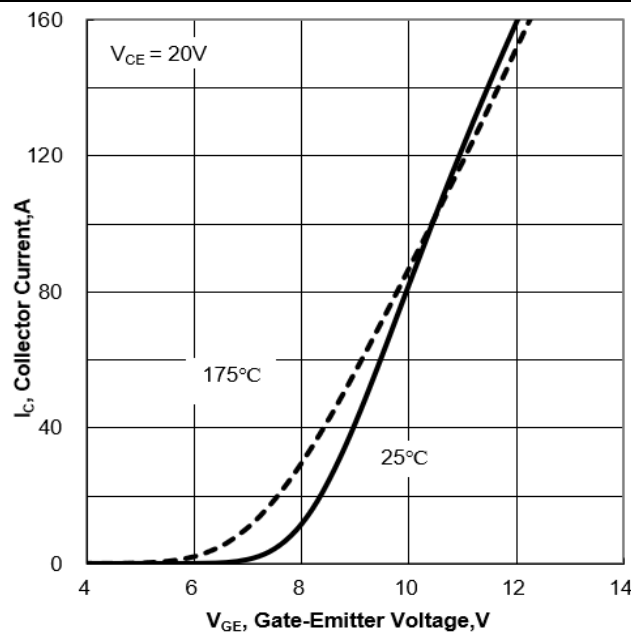


Figure 5. Typical Output Characteristics
($T_J=25^\circ\text{C}$)

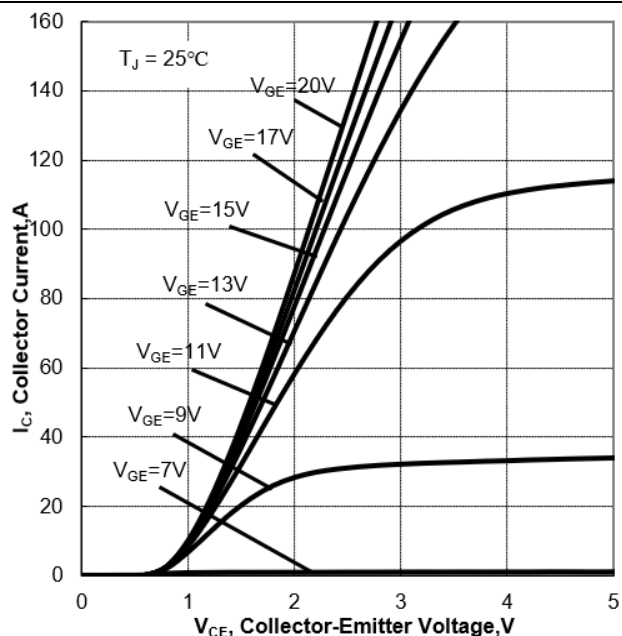


Figure 6. Typical Output Characteristics
($T_J=175^\circ\text{C}$)

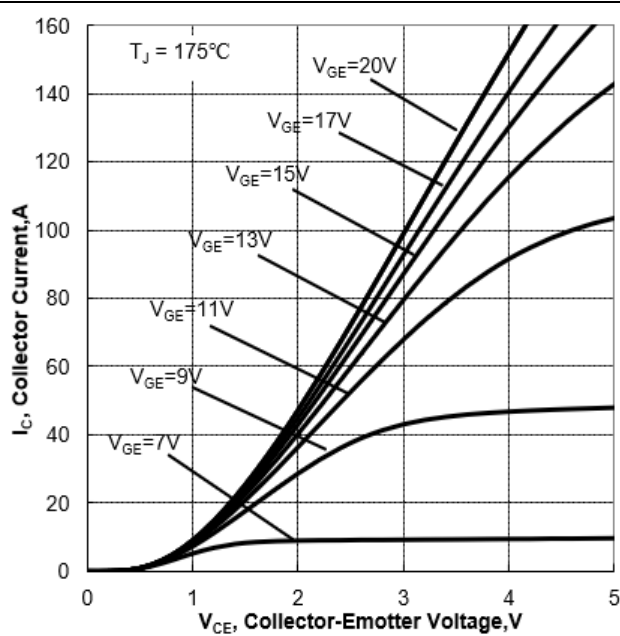


Figure 7. Typical Collector-Emitter Saturation
Voltage vs Junction Temperature

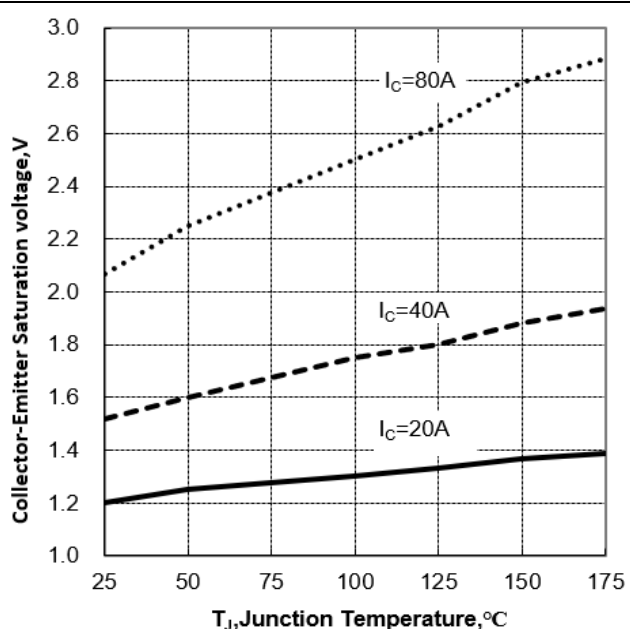


Figure 8. Typical Gate-Emitter Threshold Voltage
vs Junction Temperature

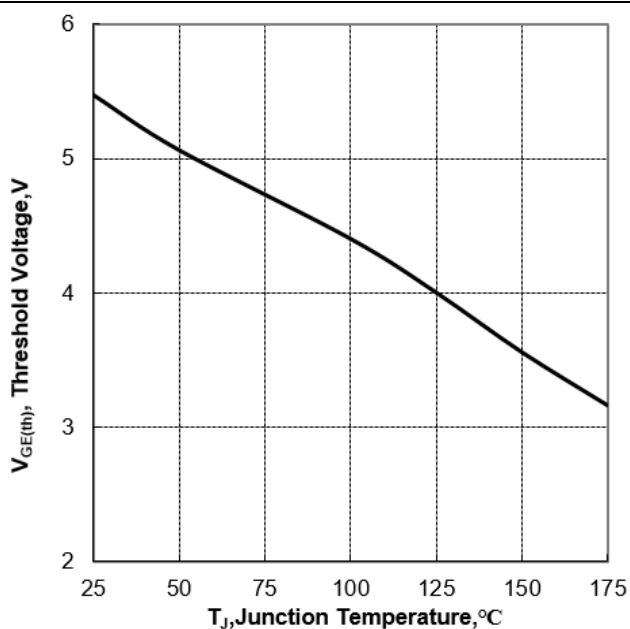


Figure 9. Typical Switching Times vs Gate Resistor ($T_J=25^{\circ}\text{C}$, $V_{CE}=400\text{V}$, $V_{GE}=15/0\text{V}$, $I_C=40\text{A}$)

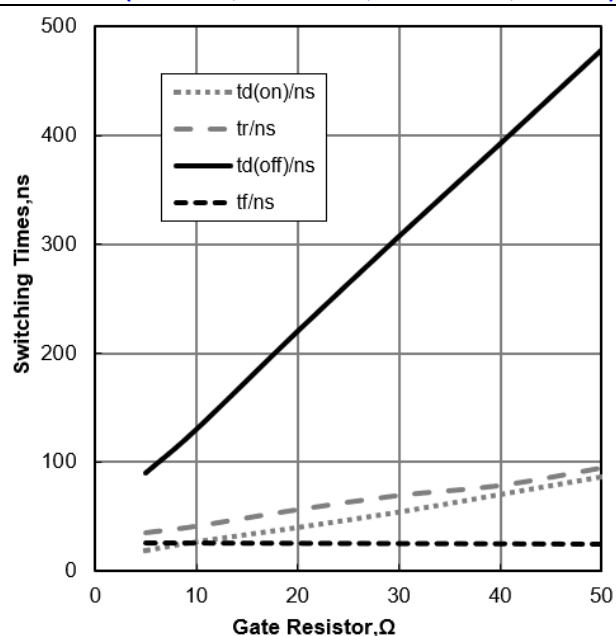


Figure 10. Typical Switching Energy vs Gate Resistor ($T_J=25^{\circ}\text{C}$, $V_{CE}=400\text{V}$, $V_{GE}=15/0\text{V}$, $I_C=40\text{A}$)

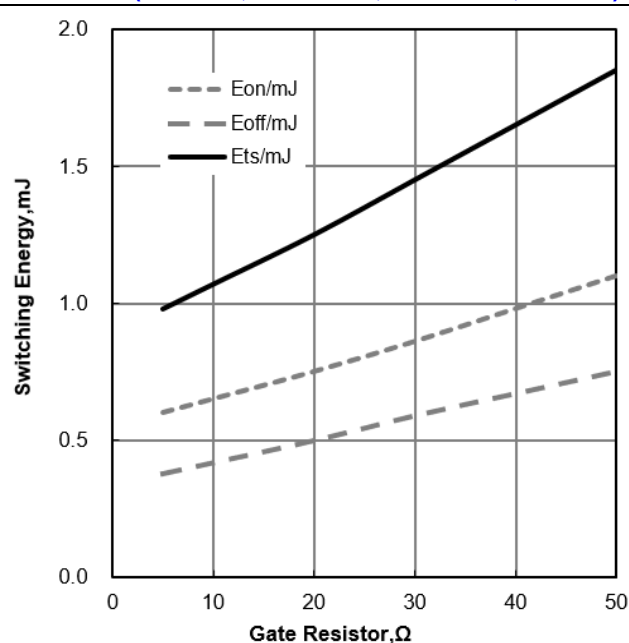


Figure 11. Typical Switching Times vs Junction Temperature ($V_{CE}=400\text{V}$, $V_{GE}=15/0\text{V}$, $I_C=40\text{A}$)

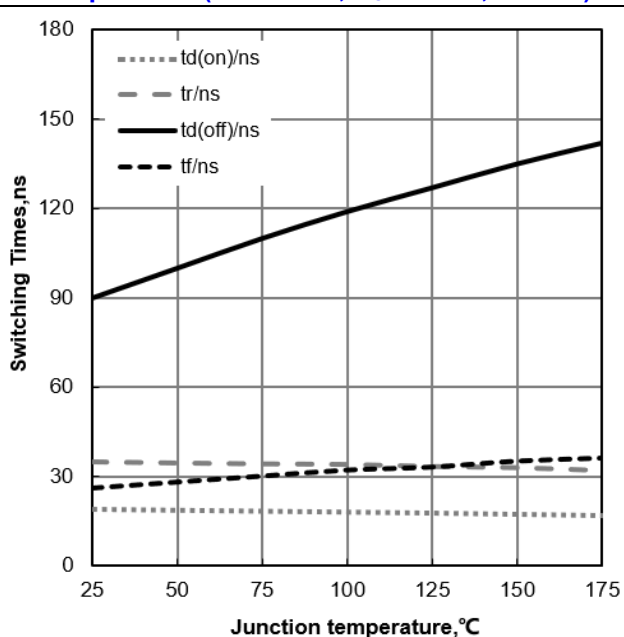


Figure 12. Typical Switching Energy vs Junction Temperature ($V_{CE}=400\text{V}$, $V_{GE}=15/0\text{V}$, $I_C=40\text{A}$)

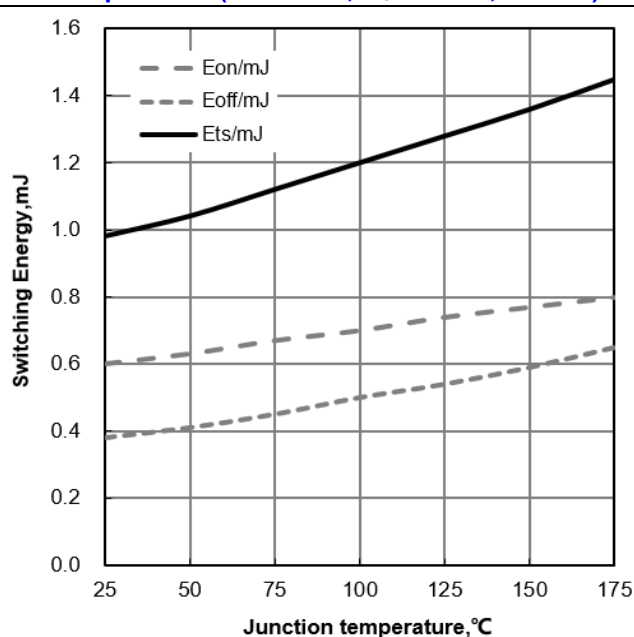


Figure 13. Typical Switching Times vs Collector Current ($T_J=25^{\circ}\text{C}$, $V_{CE}=400\text{V}$, $V_{GE}=15/0\text{V}$)

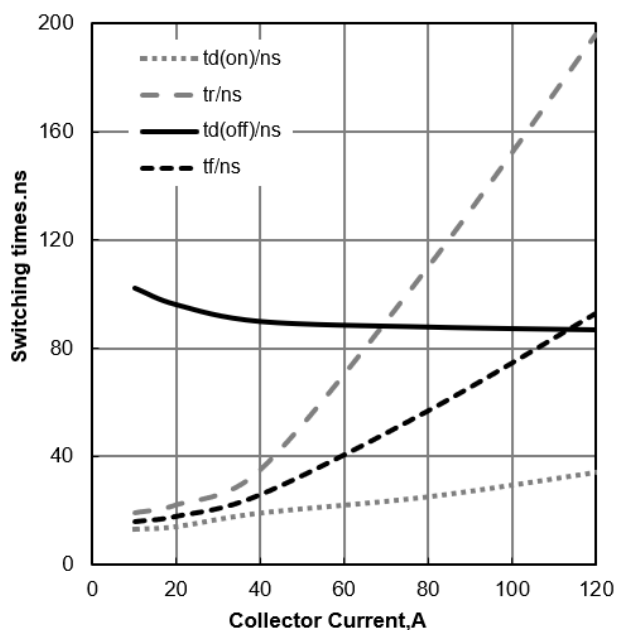


Figure 14. Typical Switching Energy vs Collector Current ($T_J=25^{\circ}\text{C}$, $V_{CE}=400\text{V}$, $V_{GE}=15/0\text{V}$)

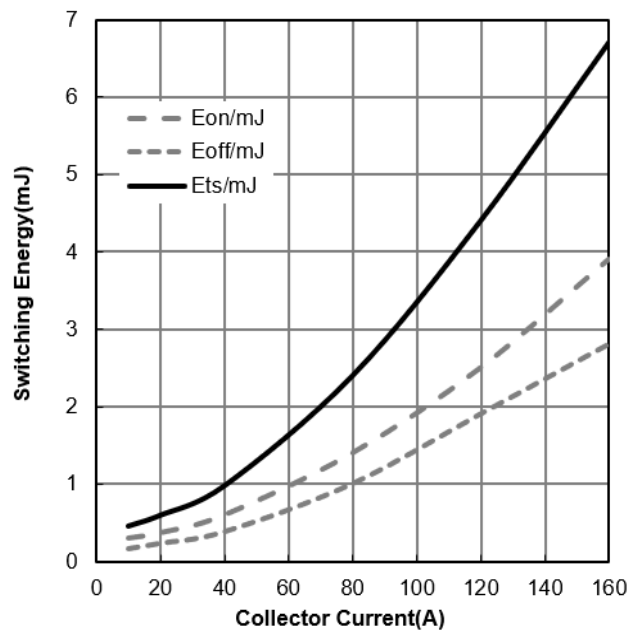


Figure 15. Typical Switching Times vs V_{CE} ($T_J=25^{\circ}\text{C}$, $V_{GE}=15/0\text{V}$, $I_C=40\text{A}$)

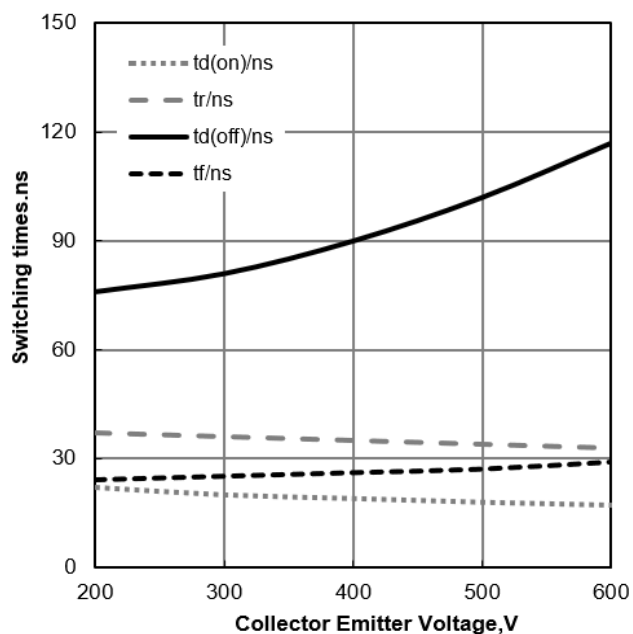


Figure 16. Typical Switching Energy vs V_{CE} ($T_J=25^{\circ}\text{C}$, $V_{GE}=15/0\text{V}$, $I_C=40\text{A}$)

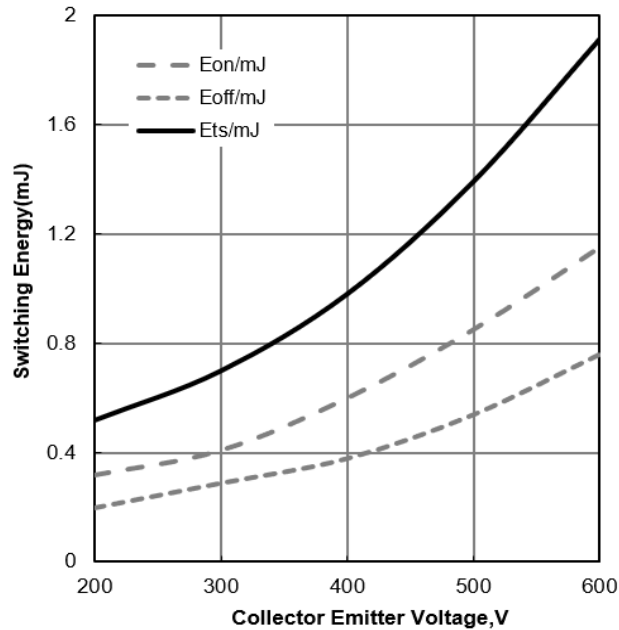


Figure 17. Typical Gate Charge

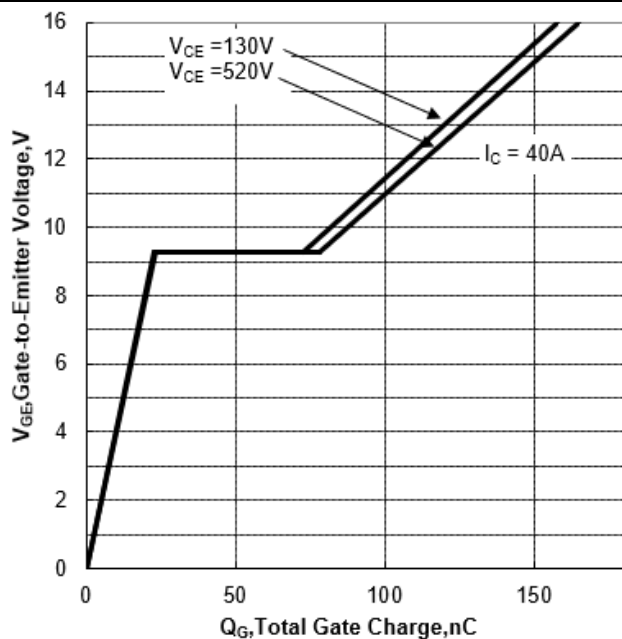


Figure 18. Typical Capacitance vs Collector-Emitter Voltage

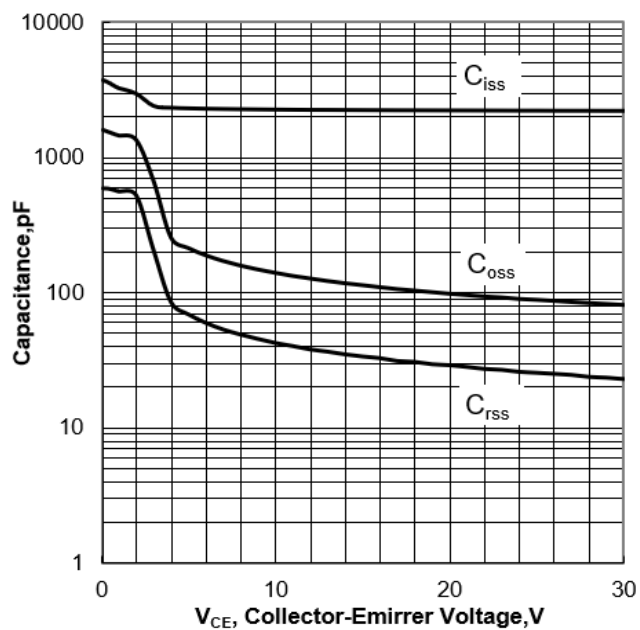


Figure 19. IGBT Transient Thermal Impedance vs Pulse Width(TO3PN/TO247)

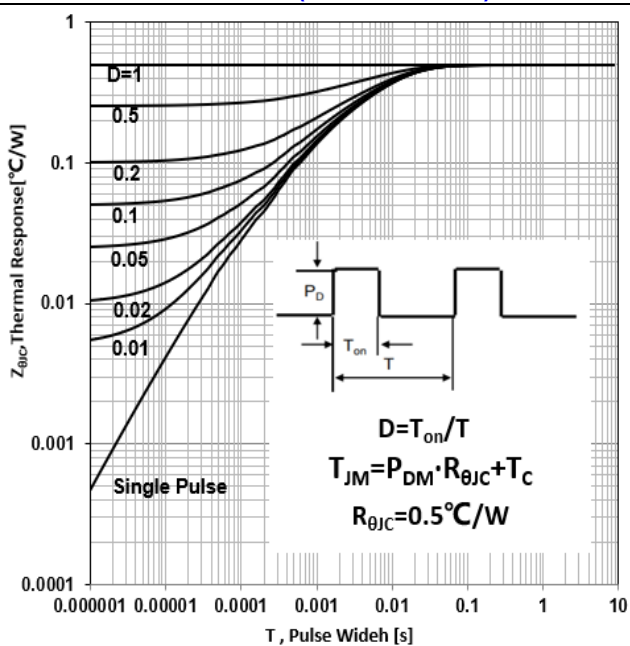


Figure 20. Diode Transient Thermal Impedance vs Pulse Width(TO3PN/TO247)

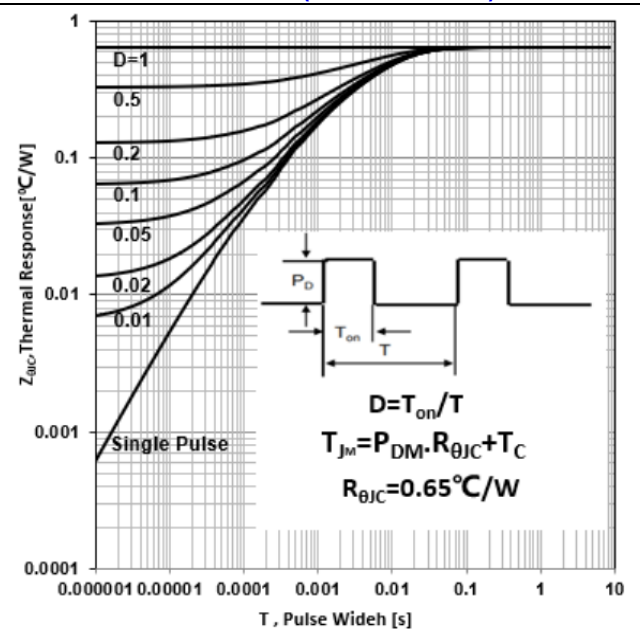
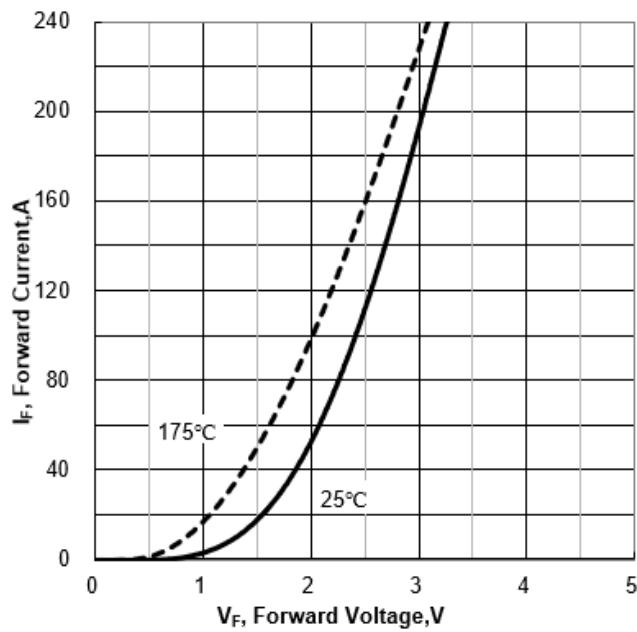


Figure 21. Typical Diode Forward Current vs Forward Voltage



6. Test Circuit and Waveform

Figure 22. Inductive Switching Test Circuit

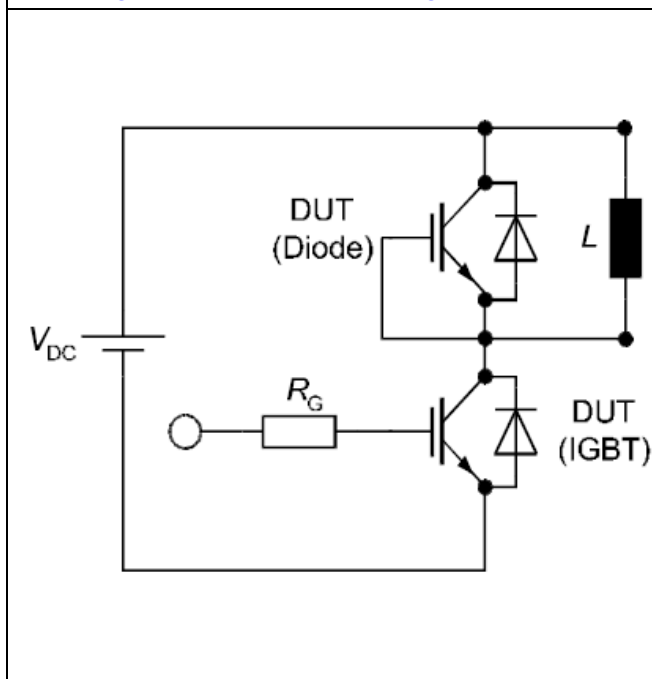


Figure 23. Definition of switching times

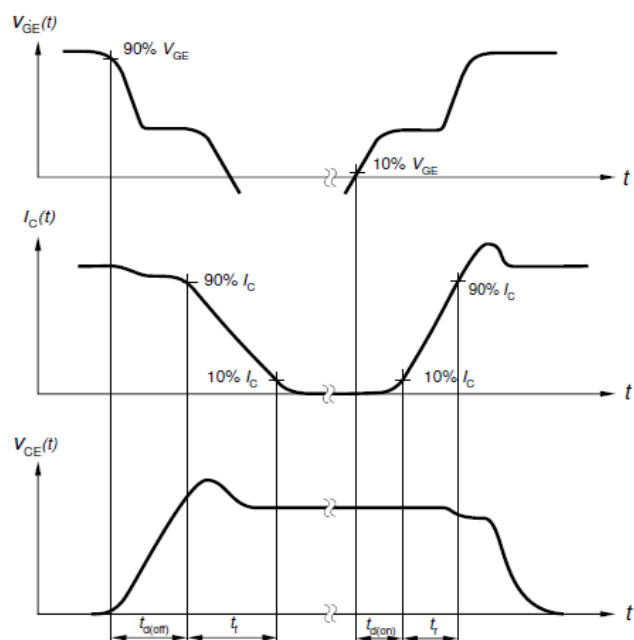


Figure 24. Definition of switching losses

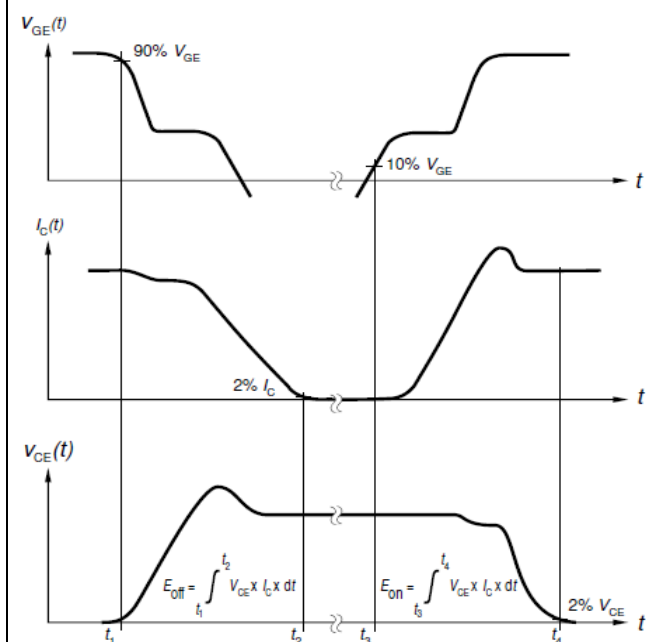
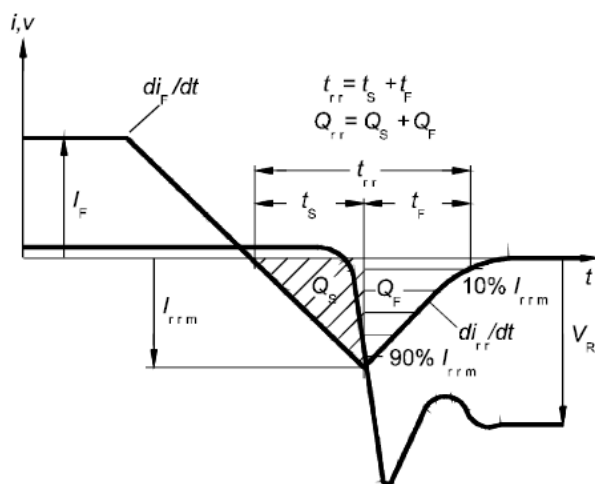
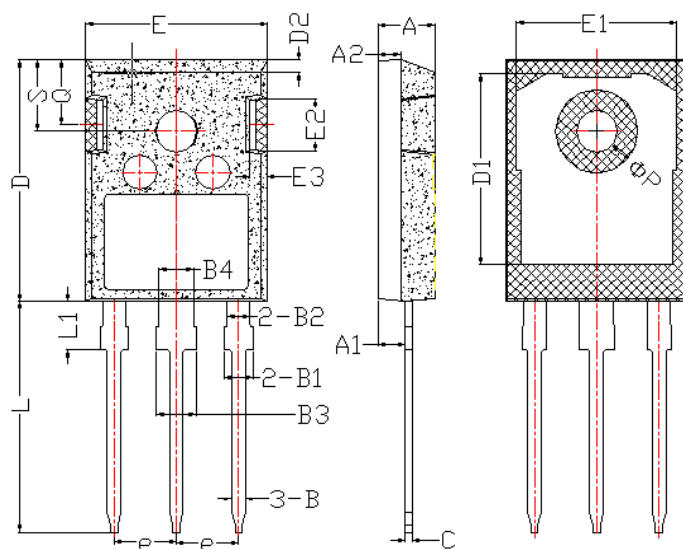


Figure 25. Definition of diode switching characteristics



7. Package Description



TO-247 Package

Items	Values(mm)	
	MIN	MAX
A	4.90	5.16
A1	2.27	2.53
A2	1.85	2.11
B	1.07	1.33
B1	1.90	2.41
B2	1.75	2.15
B3	2.87	3.38
B4	2.87	3.13
C	0.55	0.68
D	20.82	21.10
D1	16.25	17.65
D2	1.05	1.35
E	15.70	16.03
E1	13.10	14.15
E2	3.68	5.10
E3	1.68	2.60
e	5.44	
L	19.80	20.31
L1	4.17	4.47
ΦP	3.50	3.70
Q	5.49	6.00
S	6.04	6.30